

HSF

SPECIFICATIONS

Rated Current:3AMP

Contact Resistance:50mΩ Max

Withstand Voltage:1000VAC for 1 minute

Insulation Resistance:1000MΩ Min

Operation Temperature:-20℃ to +85℃

Mating force:1.96N Max

Un-mating force:0.49N Min

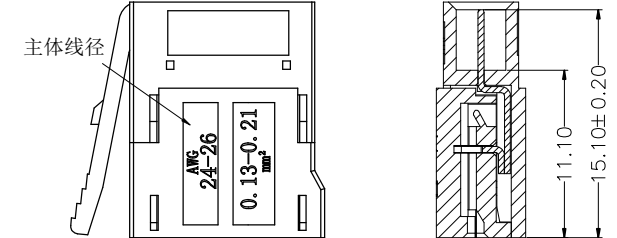
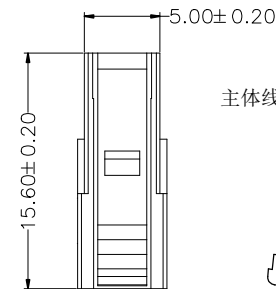
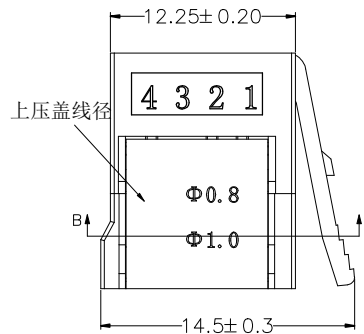
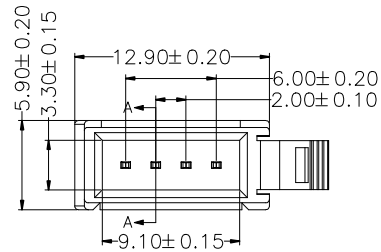
Contact Material:Copper Alloy

Contact Plating:Au Over Ni

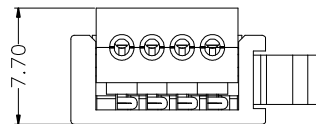
Housing Materials: PBT UL94V-0

Bottom Cover Materials: PC UL94V-0

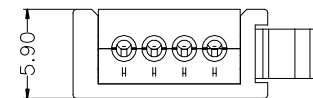
Top Cover Materials: PC UL94V-0



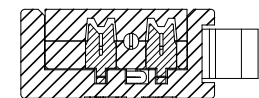
A-A SECTION



打开状态




压合状态



B-B SECTION

主体颜色	上压盖颜色	上压盖线径	主体线径
黑色	紫色	φ0.6-0.8	AWG26-24 0.13-0.21MM ²
	红色	φ0.8-1.0	
	黄色	φ1.0-1.2	
	橙色	φ1.2-1.6	
	绿色	φ1.0-1.2	AWG20-22 0.32-0.50MM ²
	蓝色	φ1.2-1.6	
	灰色	φ1.6-2.0	

				OPERATION		DRAW	OUYANG	22.03.02	SCALE	FIT	<div>JILN®深圳市锦凌电子有限公司</div> <div>SHENZHEN JINLING ELECTRONICS CO.,LTD</div> <div>Tel: 86-755-27483253 Fax: 86-755-2997-5992</div>	
				X.X	± 0.30				UNIT	mm		
				X.XX	± 0.20	CHECK			SIZE	A4	PART NO.	8310-M04G1AX0X
A0	2022.03.02	NEW DRAWING		X.XXX	± 0.10				SHEET	1/1		
REV	DATE	MODIFICATION DESCRIPTION		CHANGE	Angle ± 3°	APPROVE			PROJ.		TITLE:	四芯公座
				DIM	TOL							